

74LVC32A-Q100

Quad 2-input OR gate

Rev. 4 — 27 May 2020

Product data sheet

1. General description

The 74LVC32A-Q100 is a quad 2-input OR gate. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.2 V to 3.6 V
- Overvoltage tolerant inputs to 5.5 V
- CMOS low power dissipation
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|-----------------|-------------------|----------|------------------------------------------------------------------------------------------------------------------------------|----------|
| | Temperature range | Name | Description | Version |
| 74LVC32AD-Q100 | -40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74LVC32APW-Q100 | -40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74LVC32ABQ-Q100 | -40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

4. Functional diagram



Fig. 1. Logic symbol



Fig. 2. IEC logic symbol

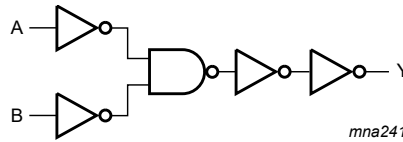


Fig. 3. Logic diagram for one gate

5. Pinning information

5.1. Pinning

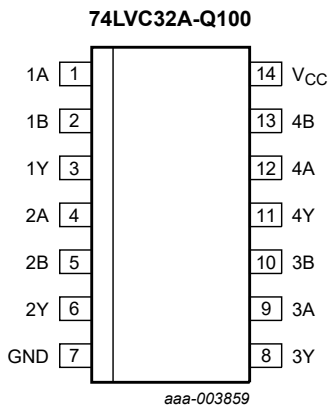


Fig. 4. Pin configuration SOT108-1 (SO14)

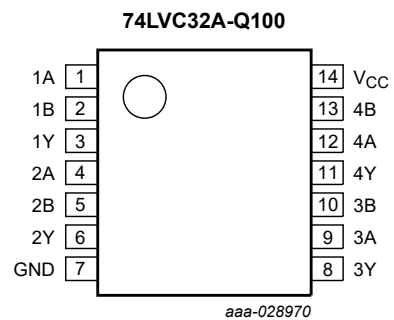
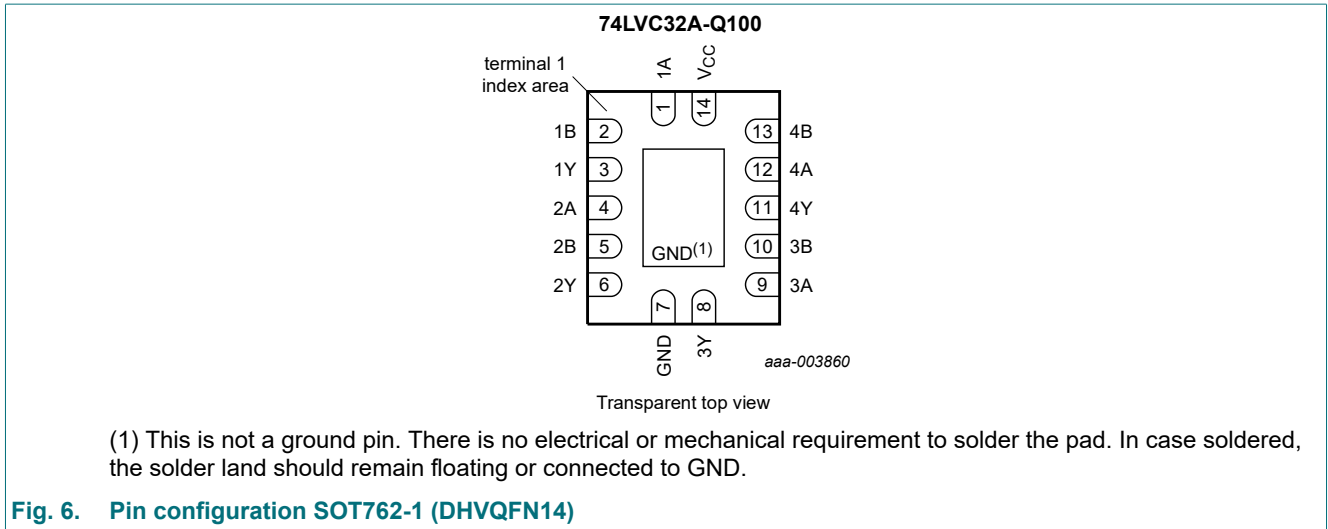


Fig. 5. Pin configuration SOT402-1 (TSSOP14)



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------|----------------|
| 1A, 2A, 3A, 4A | 1, 4, 9, 12 | data input |
| 1B, 2B, 3B, 4B | 2, 5, 10, 13 | data input |
| 1Y, 2Y, 3Y, 4Y | 3, 6, 8, 11 | data output |
| GND | 7 | ground (0 V) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function selection

H = HIGH voltage level; L = LOW voltage level; X = don't care

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | L |
| X | H | H |
| H | X | H |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|-------------------------------|----------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I_{IK} | input clamping current | $V_I < 0$ | -50 | - | mA |
| V_I | input voltage | | [1] -0.5 | +6.5 | V |
| I_{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ | - | ± 50 | mA |
| V_O | output voltage | | [2] -0.5 | $V_{CC} + 0.5$ | V |
| I_O | output current | $V_O = 0$ V to V_{CC} | - | ± 50 | mA |
| I_{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40$ °C to +125 °C | [3] - | 500 | mW |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.

For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package: P_{tot} derates linearly with 9.6 mW/K above 98 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------------|----------------------------|------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 3.6 | V |
| | | functional | 1.2 | - | - | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.65$ V to 2.7 V | 0 | - | 20 | ns/V |
| | | $V_{CC} = 2.7$ V to 3.6 V | 0 | - | 10 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------|-----------------------|---------|---------------------|-----------------------|---------------------|------|
| | | | Min | Typ [1] | Max | Min | Max | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 1.2 V | 1.08 | - | - | 1.08 | - | V |
| | | V _{CC} = 1.65 V to 1.95 V | 0.65V _{CC} | - | - | 0.65V _{CC} | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 1.2 V | - | - | 0.12 | - | 0.12 | V |
| | | V _{CC} = 1.65 V to 1.95 V | - | - | 0.35V _{CC} | - | 0.35V _{CC} | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | |
| | | I _O = -100 µA; V _{CC} = 1.65 V to 3.6 V | V _{CC} - 0.2 | - | - | V _{CC} - 0.3 | - | V |
| | | I _O = -4 mA; V _{CC} = 1.65 V | 1.2 | - | - | 1.05 | - | V |
| | | I _O = -8 mA; V _{CC} = 2.3 V | 1.8 | - | - | 1.65 | - | V |
| | | I _O = -12 mA; V _{CC} = 2.7 V | 2.2 | - | - | 2.05 | - | V |
| | | I _O = -18 mA; V _{CC} = 3.0 V | 2.4 | - | - | 2.25 | - | V |
| | | I _O = -24 mA; V _{CC} = 3.0 V | 2.2 | - | - | 2.0 | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | |
| | | I _O = 100 µA; V _{CC} = 1.65 V to 3.6 V | - | - | 0.2 | - | 0.3 | V |
| | | I _O = 4 mA; V _{CC} = 1.65 V | - | - | 0.45 | - | 0.65 | V |
| | | I _O = 8 mA; V _{CC} = 2.3 V | - | - | 0.6 | - | 0.8 | V |
| | | I _O = 12 mA; V _{CC} = 2.7 V | - | - | 0.4 | - | 0.6 | V |
| | | I _O = 24 mA; V _{CC} = 3.0 V | - | - | 0.55 | - | 0.8 | V |
| I _I | input leakage current | V _{CC} = 3.6 V; V _I = 5.5 V or GND | - | ±0.1 | ±5 | - | ±20 | µA |
| I _{CC} | supply current | V _{CC} = 3.6 V; V _I = V _{CC} or GND; I _O = 0 A | - | 0.1 | 10 | - | 40 | µA |
| ΔI _{CC} | additional supply current | per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A | - | 5 | 500 | - | 5000 | µA |
| C _I | input capacitance | V _{CC} = 0 V to 3.6 V; V _I = GND to V _{CC} | - | 4.0 | - | - | - | pF |

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 8.

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|-------------|-------------------------------|------------------------------------------------|------------------|---------|-----|-------------------|------|------|
| | | | Min | Typ [1] | Max | Min | Max | |
| t_{pd} | propagation delay | nA, nB to nY; see Fig. 7 [2] | | | | | | |
| | | $V_{CC} = 1.2 \text{ V}$ | - | 10 | - | - | - | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 0.5 | 4.2 | 9.0 | 0.5 | 10.4 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.5 | 2.4 | 4.9 | 1.5 | 5.7 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.5 | 2.5 | 4.4 | 1.5 | 5.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 2.2 | 3.8 | 1.0 | 5.0 | ns |
| $t_{sk(o)}$ | output skew time | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ [3] | - | - | 1.0 | - | 1.5 | ns |
| C_{PD} | power dissipation capacitance | per gate; $V_I = \text{GND to } V_{CC}$ [4] | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | - | 4.7 | - | - | - | pF |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | 8.0 | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | - | 11.0 | - | - | - | pF |

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$ and $V_{CC} = 1.2 \text{ V}, 1.8 \text{ V}, 2.5 \text{ V}, 2.7 \text{ V},$ and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

10.1. Waveforms and test circuit

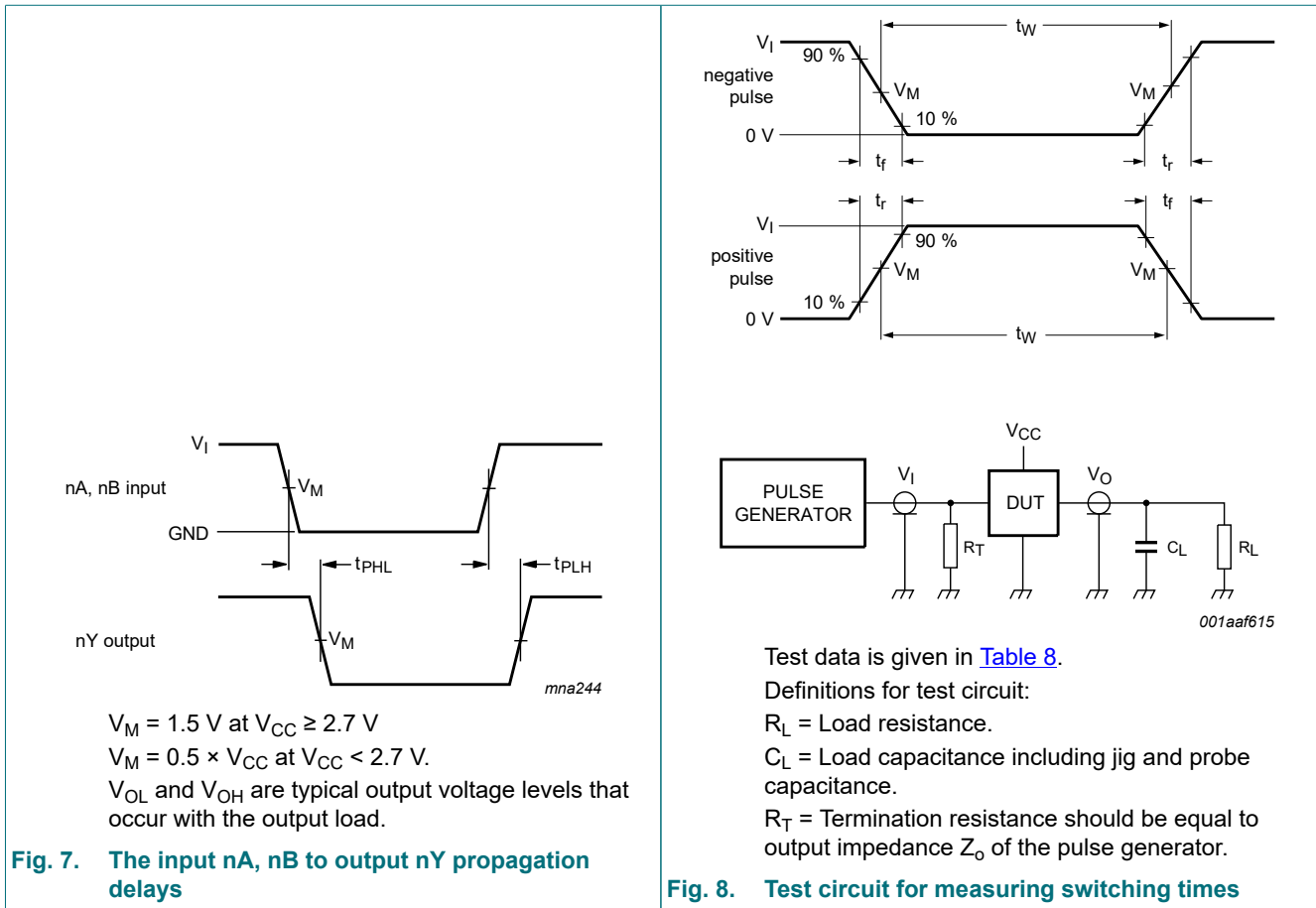


Table 8. Test data

| Supply voltage | Input | | Load | |
|------------------|----------|-----------------------|-------|--------------|
| | V_I | t_r, t_f | C_L | R_L |
| 1.2 V | V_{CC} | $\leq 2 \text{ ns}$ | 30 pF | 1 k Ω |
| 1.65 V to 1.95 V | V_{CC} | $\leq 2 \text{ ns}$ | 30 pF | 1 k Ω |
| 2.3 V to 2.7 V | V_{CC} | $\leq 2 \text{ ns}$ | 30 pF | 500 Ω |
| 2.7 V | 2.7 V | $\leq 2.5 \text{ ns}$ | 50 pF | 500 Ω |
| 3.0 V to 3.6 V | 2.7 V | $\leq 2.5 \text{ ns}$ | 50 pF | 500 Ω |

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Fig. 9. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



Fig. 10. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1



Fig. 11. Package outline SOT762-1 (DHVQFN14)

12. Abbreviations

Table 9. Abbreviations

| Acronym | Description |
|---------|-----------------------------------------|
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|---------------|-------------------|
| 74LVC32A_Q100 v.4 | 20200527 | Product data sheet | - | 74LVC32A_Q100 v.3 |
| Modifications: | <ul style="list-style-type: none"> Section 1 and Section 2 updated. Table 4: Derating values for P_{tot} total power dissipation updated. | | | |
| 74LVC32A_Q100 v.3 | 20180912 | Product data sheet | - | 74LVC32A_Q100 v.2 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74LVC32ADB-Q100 (SOT337-1) removed. Package outline drawing SOT762-1 updated. Typo corrected in t_{pd} value: 1.05 ns to 1.5 ns. | | | |
| 74LVC32A_Q100 v.2 | 20130228 | Product data sheet | - | 74LVC32A_Q100 v.1 |
| Modifications: | <ul style="list-style-type: none"> 74LVC32ADB-Q100 (SSOP14) added. | | | |
| 74LVC32A_Q100 v.1 | 20120807 | Product data sheet | - | - |

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
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- [2] The term 'short data sheet' is explained in section "Definitions".
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